

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5689379

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YONGHO SEOK	08/23/2019
JIANHAN LIU	08/23/2019
GABOR BAJKO	08/23/2019
JAMES CHIH-SHI YEE	08/23/2019
RECEIVING PARTY DATA	
Name:	MEDIATEK SINGAPORE PTE. LTD.
Street Address:	NO. 1, FUSIONOPOLIS WALK, #03-01
City:	SOLARIS
State/Country:	SINGAPORE
Postal Code:	138628
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16552420
CORRESPONDENCE DATA	
Fax Number:	(408)938-9069
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	408-938-9060
Email:	officeaction@mhbpatents.com
Correspondent Name:	MEDIATEK, INC. C/O MURABITO, HAO & BARNE
Address Line 1:	111 NORTH MARKET STREET
Address Line 2:	SUITE 700
Address Line 4:	SAN JOSE, CALIFORNIA 95113
ATTORNEY DOCKET NUMBER:	MEDT-0050-01U00US
NAME OF SUBMITTER:	NING LI
SIGNATURE:	/Ning Li/
DATE SIGNED:	08/27/2019
Total Attachments: 1	
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Attorney Docket No.: MEDT-0050-01U000US

Assignment to **MEDIATEK SINGAPORE PTE. LTD.**

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we

Yongho Seok, Jianhan Liu, Gabor Bajko, James Chih-Shi Yee

do hereby sell, assign, and transfer unto **MEDIATEK SINGAPORE PTE. LTD.** (hereinafter called **MEDIATEK**), a Corporation of the Republic of China having its principal place of business at No. 1, Fusionopolis Walk, #03-01 Solaris, Singapore 138628, and its successors and assigns, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

EXTREMELY HIGH THROUGHPUT (EHT) MULTI-BAND TRANSMISSION

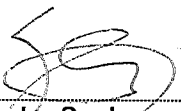
 X filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; or

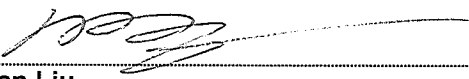
Serial No.: _____ filed on _____ and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor;

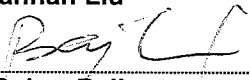
And for the above consideration, I/we agree promptly upon request of **MEDIATEK SINGAPORE PTE. LTD.**, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to **MEDIATEK SINGAPORE PTE. LTD.**, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by **MEDIATEK SINGAPORE PTE. LTD.**

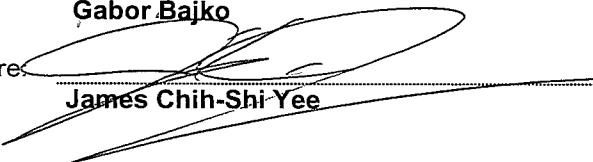
I/we further covenant with **MEDIATEK SINGAPORE PTE. LTD.**, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we hereunto set my/our hand(s) and seal:

Inventor's Signature:  Date: 08/23/2019
Yongho Seok

Inventor's Signature:  Date: 08/23/2019
Jianhan Liu

Inventor's Signature:  Date: 8/23/2019
Gabor Bajko

Inventor's Signature:  Date: 8/23/2019
James Chih-Shi Yee